ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserve	tion with lower	level p	arts, the	declaratior	n encor		er level mat	erials for	which th	e item is an assembly ne manufacturer has eclaration.		
1752-2 1.1 IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x						Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa							
Supplier Information																
Company Name * Company Unique ID				Unique ID Au	ıthority	Respo	onse Date	e *		Response Doo						
SEMTECH CORPORATION	ON	00-847-9941		DUNS	2014-02-11											
Contact Name * Roya Motamedi		Title - Contact QA Customer Servic	e Specialis				Email - Contact * rmotamedi@semtech.com			Duplicate	e Contact	-> Autho	orized Re	presentative		
Authorized Representati Roya Motamedi	ive *	Title - Representative QA Customer Service		Phone - Rep 805-389-274	Email - Representative * rmotamedi@semtech.com				Supplier Comr	nents or UR	L for Add	ditional Ir	formation			
Requester Item Number		Mfr Item Number		Mfr Item Name		Effectiv	e Date	Version	Manufa	cturing Site	Weight *	UC	OM	Unit Type		
		SX8651IWLTRT		Multitouch 4-wire Resistive Tou		ıc		Malay		ia	16.2	m	9	Each		
Alternate Recommend	Alternate Recommendation							Alternate	Item Co	mments	•					
Manufacturing Proces	ss In	formation														
Terminal Plating / Grid Array Material			Terminal Base Alloy		J-STD-020 MSL Ra	ating	Peak Prod	cess Body Tempera		ature Max Time	at Peak Tem	ak Temperature		of Reflow Cycles		
Nickel/Palladium/Gold (Ni/Pd/Au)			CU Alloy		1			(S	seconds				
SX8651IWLTRT is REAC	СН-сс	ompliant product, pe	er EU Regi	ulation EC19	07/2006 to includ	e recei	nt additio	n of SVH	IC can	didate list of	substances	in Dece	mber 20	13.		

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type *** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a ?RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier?s liability and the Company?s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance * Accepted **RoHS Declaration *** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature**

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

		Item/SubItem			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight	OTHE OF	Tolerance		PPM
		Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	vveignt	Measure	-	+	
+I	-1	Leadframe	+M	-М	C194	6.56	mg	+C -	C	Supplier		+S	-S	Copper	7440-50-8		6.34	mg			391,12
												+S	-s	Iron	7439-89-6		0.15	mg			9,135.4
								+C -	C	A	Lead/Lead Compound	+S	-s	Lead	7439-92-1		0.0002	mg			12.15
								+C -	С	Supplier		+S	-s	Phophorus	7723-14-0		0.0016	mg			97.19
												+S	-s	Zinc	7440-66-6		0.008	mg			514.27
												+S	-s	Silver	7440-22-4		0.066	mg			4,049.3
+I	-I	Die	+M	-М	Silicon Chip	0.59	mg	+C -	C	Supplier		+S	-S	Si	7440-21-3		0.59	mg			36,419
+I	-1	Die attach material	+M	-M	QMI519 conduct	i0.28	mg	+C -	C	Supplier		+S	-S	Silver	7440-22-4		0.2	mg			12,271
	·		-						Ī			+S	-s	Carbocycllic Acrylate	Proprietary		0.06	mg			3,456.7
												+S	-s	Bismaleimide resin	Proprietary		0.008	mg			518.52
												+S	-s	Acrylate	Proprietary		0.008	mg			518.52
												+S	-s	Additive	Proprietary		0.008	mg			518.52
+I	-I	Wire	+M	-М	Gold	0.11	mg	+C -	C	Supplier		+S	-S	Au	7440-57-5		0.11	mg			6,790.1
+I	-1	Lead finish	+M	-M	Tin alloy	0.47	mg	+C -	C	Supplier		+S	-S	Sn	7440-31-5		0.47	mg			29,012
+I	-1	Encapsulation	+M	-M	EME-G770HC ep	8.19	mg	+C -	C	Supplier		+S	-S	Silica fused	60676-86-0		7.67	mg			473,70
			-									+S	-s	Epoxy resin	Proprietary		0.25	mg			15,166
												+S	-s	Phenol resin	Proprietary		0.25	mg			15,166
												+S	-s	С	1333-86-4		0.02	mg			1,516.6